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FSB50550T Motion SPM[®] 5 Series

Features

- UL Certified No. E209204 (UL1557)
- 500 V R_{DS(on)} = 1.7 Ω(Max) FRFET MOSFET 3-Phase Inverter with Gate Drivers
- Separate Open-Source Pins from Low-Side MOSFETs for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3 / 5 V Logic, Schmitt-trigger Input
- Optimized for Low Electromagnetic Interference
- HVIC for Gate Driving and Under-Voltage Protection
- Isolation Rating: 1500 V_{rms} / min.
- RoHS Compliant

Applications

 3-Phase Inverter Driver for Small Power AC Motor Drives

Related Source

- <u>AN-9082 Motion SPM5 Series Thermal Performance</u> <u>by Contact Pressure</u>
- AN-9080 User's Guide for Motion SPM 5 Series Ver.1

General Description

The FSB50550T is an advanced Motion SPM[®] 5 module providing a fully-featured, high-performance inverter output stage for AC Induction, BLDC and PMSM motors. These modules integrate optimized gate drive of the built-in MOSFETs (FRFET[®] technology) to minimize EMI and losses. The built-in, high-speed HVIC requires only a single supply voltage and translates the incoming logic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's internal MOSFETs. Separate open-source MOSFET terminals are available for each phase to support the widest variety of control algorithms.



Package Marking & Ordering Information

| Device | Device Marking | Package | Packing Type | Quantity |
|-----------|----------------|-----------|--------------|----------|
| FSB50550T | FSB50550T | SPM5F-023 | Rail | 15 |

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Absolute Maximum Ratings

Inverter Part (each MOSFET unless otherwise specified.)

| Symbol | Parameter | Conditions | Rating | Unit |
|--------------------|---------------------------------------|---|--------|------|
| V _{DSS} | Drain-Source Voltage of Each MOSFET | | 500 | V |
| *I _{D 25} | Each MOSFET Drain Current, Continuous | $T_{C} = 25^{\circ}C$ | 1.8 | A |
| *I _{D 80} | Each MOSFET Drain Current, Continuous | $T_{C} = 80^{\circ}C$ | 1.2 | A |
| *I _{DP} | Each MOSFET Drain Current, Peak | T _C = 25°C, PW < 100 μs | 3.5 | A |
| *P _D | Maximum Power Dissipation | $T_{C} = 25^{\circ}C$, For Each MOSFET | 4.5 | W |

Control Part (each HVIC unless otherwise specified.)

| Symbol | Parameter | Conditions | Rating | Unit |
|-----------------|------------------------|---|------------------------------|------|
| V _{CC} | Control Supply Voltage | Applied Between V _{CC} and COM | 20 | V |
| V _{BS} | High-side Bias Voltage | Applied Between V_B and V_S | 20 | V |
| V _{IN} | Input Signal Voltage | Applied Between IN and COM | -0.3 ~ V _{CC} + 0.3 | V |

Thermal Resistance

| Symbol | Parameter | Conditions | Rating | Unit |
|-----------------------|-------------------------------------|--|--------|------|
| $R_{	extsf{	heta}JC}$ | Junction to Case Thermal Resistance | Each MOSFET under Inverter Oper- ating Condition (1st Note 1) | 8.6 | °C/W |

Total System

| olai Sysle | | | | |
|------------------|--------------------------------|---|-----------|------------------|
| Symbol | Parameter | Conditions | Rating | Unit |
| TJ | Operating Junction Temperature | | -20 ~ 150 | °C |
| T _{STG} | Storage Temperature | | -50 ~ 150 | °C |
| V _{ISO} | Isolation Voltage | 60 Hz, Sinusoidal, 1 Minute, Con- nect Pins to Heat Sink Plate | 1500 | V _{rms} |

1st Notes:

1. For the measurement point of case temperature $\mathsf{T}_\mathsf{C},$ please refer to Figure 4.

2. Marking "*" is calculation value or design factor.

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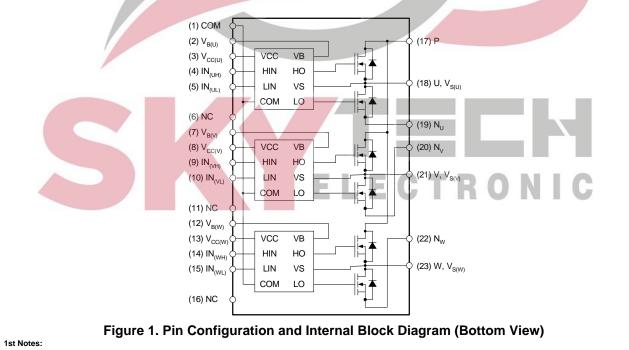
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ELECTRO

| FSB505501 |
|---------------|
| Motion |
| SPM® 5 Series |

Pin descriptions

| Pin Number | Pin Name | Pin Description | |
|------------|----------------------|---|--|
| 1 | COM | IC Common Supply Ground | |
| 2 | V _{B(U)} | Bias Voltage for U Phase High Side MOSFET [®] Driving | |
| 3 | V _{CC(U)} | ias Voltage for U Phase IC and Low Side MOSFET Driving | |
| 4 | IN _(UH) | Signal Input for U Phase High-Side | |
| 5 | IN _(UL) | Signal Input for U Phase Low-Side | |
| 6 | N.C | No Connectiion | |
| 7 | V _{B(V)} | Bias Voltage for V Phase High Side MOSFET Driving | |
| 8 | V _{CC(V)} | Bias Voltage for V Phase IC and Low Side MOSFET Driving | |
| 9 | IN _(VH) | Signal Input for V Phase High-Side | |
| 10 | IN _(VL) | Signal Input for V Phase Low-Side | |
| 11 | N.C | No Connectiion | |
| 12 | V _{B(W)} | Bias Voltage for W Phase High Side MOSFET Driving | |
| 13 | V _{CC(W)} | Bias Voltage for W Phase IC and Low Side MOSFET Driving | |
| 14 | IN _(WH) | Signal Input for W Phase High-Side | |
| 15 | IN _(WL) | Sig <mark>nal Input fo</mark> r W Phase Low-Side | |
| 16 | N.C | No Connectiion | |
| 17 | Р | Positive DC-Link Input | |
| 18 | U, V _{S(U)} | Output for U Phase & Bias Voltage Ground for High Side MOSFET Driving | |
| 19 | NU | Negative DC-Link Input for U Phase | |
| 20 | N _V | Negative DC-Link Input for V Phase | |
| 21 | V, V _{S(V)} | Output for V Phase & Bias Voltage Ground for High Side MOSFET Driving | |
| 22 | N _W | Negative DC-Link Input for W Phase | |
| 23 | W, V _{S(W)} | Output for W Phase & Bias Voltage Ground for High Side MOSFET Driving | |



3. Source terminal of each low-side MOSFET is not connected to supply ground or bias voltage ground inside Motion SPM[®] 5 product. External connections should be made as indicated in Figure 3.

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Electrical Characteristics ($T_J = 25^{\circ}C$, $V_{CC} = V_{BS} = 15$ V unless otherwise specified.)

Inverter Part (each MOSFET unless otherwise specified.)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|---|---|-----|------|--------|------|
| BV _{DSS} | Drain - Source Breakdown Voltage | V _{IN} = 0 V, I _D = 250 μA (2nd Note 1) | 500 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{IN} = 0 V, V _{DS} = 500V | - | - | 250 | μΑ |
| R _{DS(on)} | Static Drain - Source Turn-On Resistance | V _{CC} = V _{BS} = 15 V, V _{IN} = 5 V, I _D = 1.2 A | - | 1.3 | 1.7 | Ω |
| V _{SD} | Drain - Source Diode Forward Voltage | $V_{CC} = V_{BS} = 15V, V_{IN} = 0 V, I_D = -1.2 A$ | - | - | 1.2 | V |
| t _{ON} | | | - | 560 | - | ns |
| t _{OFF} | | $V_{PN} = 300 \text{ V}, V_{CC} = V_{BS} = 15 \text{ V}, I_D = 1.2 \text{ A}$ | - | 440 | - | ns |
| t _{rr} | Switching Times | $V_{IN} = 0 V \leftrightarrow 5 V$, Inductive Load L = 3 mH High- and Low-Side MOSFET Switching | - | 130 | - | ns |
| E _{ON} | | (2nd Note 2) | - | 71 | - | μJ |
| E _{OFF} | | | - | 11 | - | μJ |
| RBSOA | Reverse Bias Safe Oper- ating Area | $V_{PN} = 400 \text{ V}, \text{ V}_{CC} = \text{V}_{BS} = 15 \text{ V}, \text{ I}_{D} = \text{I}_{DP}, \text{ V}_{DS} = \text{BV}_{DSS},$ T _J = 150°C High- and Low-Side MOSFET Switching (2nd Note 3) | | Full | Square | |

Control Part (each HVIC unless otherwise specified.)

| | | , | | | | | |
|-------------------|-----------------------------------|--|--|-----|-----|-----|------|
| Symbol | Parameter | | Conditions | Min | Тур | Max | Unit |
| IQCC | Quiescent V _{CC} Current | V _{CC} = 15 V, V _{IN} = 0 V | Applied Between V _{CC} and COM | - | - | 160 | μA |
| I _{QBS} | Quiescent V _{BS} Current | V _{BS} = 15 V, V _{IN} = 0 V | $\begin{array}{l} \mbox{Applied Between V}_{B(U)} \mbox{-} U, \\ \mbox{V}_{B(V)} \mbox{-} V, \mbox{V}_{B(W)} \mbox{-} W \end{array}$ | - | - | 100 | μA |
| UV _{CCD} | Low-Side Under-Voltage | V _{CC} Under-Voltage | Protection Detection Level | 7.4 | 8.0 | 9.4 | V |
| UV _{CCR} | Protection (Figure 8) | V _{CC} Under-Voltage | Protection Reset Level | 8.0 | 8.9 | 9.8 | V |
| UV _{BSD} | High-Side Under-Voltage | V _{BS} Under-Voltage | Protection Detection Level | 7.4 | 8.0 | 9.4 | V |
| UV _{BSR} | Protection (Figure 9) | V _{BS} Under-Voltage | Protection Reset Level | 8.0 | 8.9 | 9.8 | V |
| V _{IH} | ON Threshold Voltage | Logic HIGH Level | Applied between IN and COM | 2.9 | - | - | V |
| V _{IL} | OFF Threshold Voltage | Logic LOW Level | Applied between IN and COM | - | - | 0.8 | V |
| I _{IH} | Input Pice Current | V _{IN} = 5 V | Applied between IN and COM | - | 10 | 20 | μΑ |
| IL | Input Bias Current | $V_{IN} = 0 V$ | Applied between IN and COM | - | - | 2 | μA |

2nd Notes:

1. BV_{DSS} is the absolute maximum voltage rating between drain and source terminal of each MOSFET inside Motion SPM[®] 5 product. V_{PN} should be sufficiently less than this value considering the effect of the stray inductance so that V_{PN} should not exceed BV_{DSS} in any case.

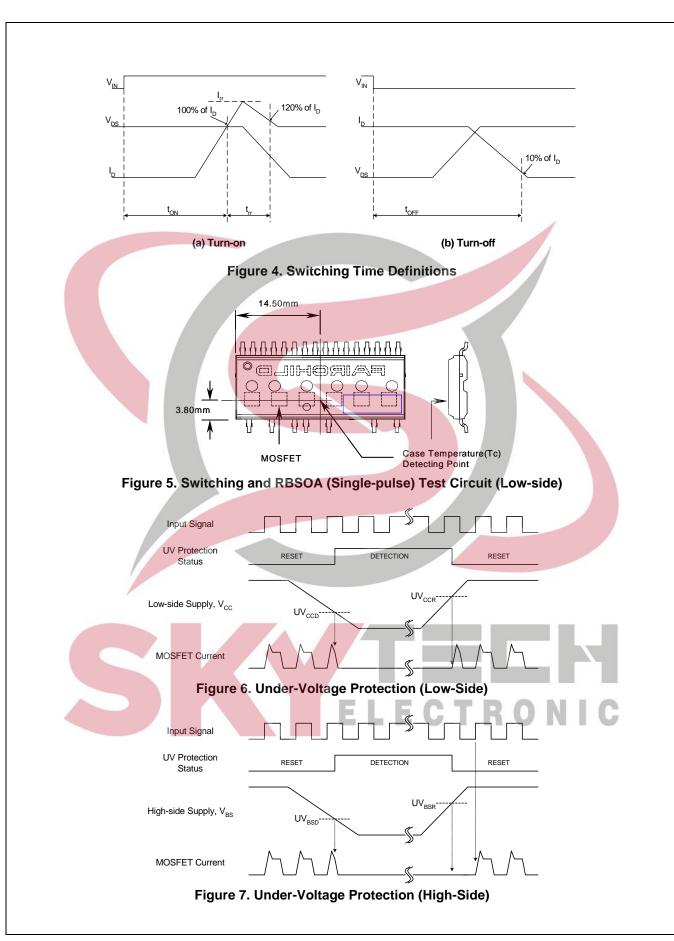
2. t_{ON} and t_{OFF} include the propagation delay of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Figure 4 for the switching time definition with the switching test circuit of Figure 5.

3. The peak current and voltage of each MOSFET during the switching operation should be included in the Safe Operating Area (SOA). Please see Figure 5 for the RBSOA test circuit that is same as the switching test circuit.

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|---|--|---|---------------------------------------|--------------------------------|-------------------------------|-------------|
| V _{PN} | Supply Voltage | Applied Between P and N | - | 300 | 400 | V |
| V _{CC} | Control Supply Voltage | Applied Between V_{CC} and COM | 13.5 | 15.0 | 16.5 | V |
| V _{BS} | High-Side Bias Voltage | Applied Between V_B and V_S | 13.5 | 15.0 | 16.5 | V |
| V _{IN(ON)} | Input ON Threshold Voltage | | 3.0 | - | V _{CC} | V |
| V _{IN(OFF)} | Input OFF Threshold Voltage | Applied Between IN and COM | 0 | - | 0.6 | V |
| t _{dead} | Blanking Time for Preventing Arm-Short | $V_{CC} = V_{BS} = 13.5 \sim 16.5 \text{ V}, \text{ T}_{J} \le 150^{\circ}\text{C}$ | 1.0 | - | - | μS |
| f _{PWM} | PWM Switching Frequency | T _J ≤ 150°C | - | 15 | - | kHz |
| т _с | Case Temperature | T _J ≤ 150°C | -20 | - , | 125 | °C |
| Micom | | VB Inverter Output | HIN LIN 0 0 0 1 | Output Z | Not Both FRF Low side F | ET Off |
| | | | 1 0 | VDC | High side F | |
| | | | 1 1 | Forbidden | Shoot th | nrough |
| | │ ┌─┤ ↓ ↓ ▼ │ └ ─── | | <mark>Op</mark> en Open | Z | Same as | s (0,0) |
| ' | | bootstrap paramters: μF ceramic capacitor, | | | | |
| rd Notes: It is recomm Parameters RC-coupling Bold lines st | • Example of $C_1 = C_2 = 1$ $R_1 = 56\Omega_2$ Figure 2. Recomme wended the bootstrap diode D ₁ to have soft for bootstrap circuit elements are depended $(R_5 \text{ and } C_5)$ and C_4 at each input of Motion hould be short and thick in PCB pattern to b and have good high-frequency characteristic | μF ceramic capacitor, Inded MCU Interface and Bootstrag and fast recovery characteristics with 600 V Rating. Int on PWM algorithm. For 15 kHz of switching frequency, typ on SPM 5 product and MCU (Indicated as Dotted Lines) may have small stray inductance of circuit, which results in the red | bical example of piece used to preven | parameters is sent improper si | shown above. | urge-noise. |

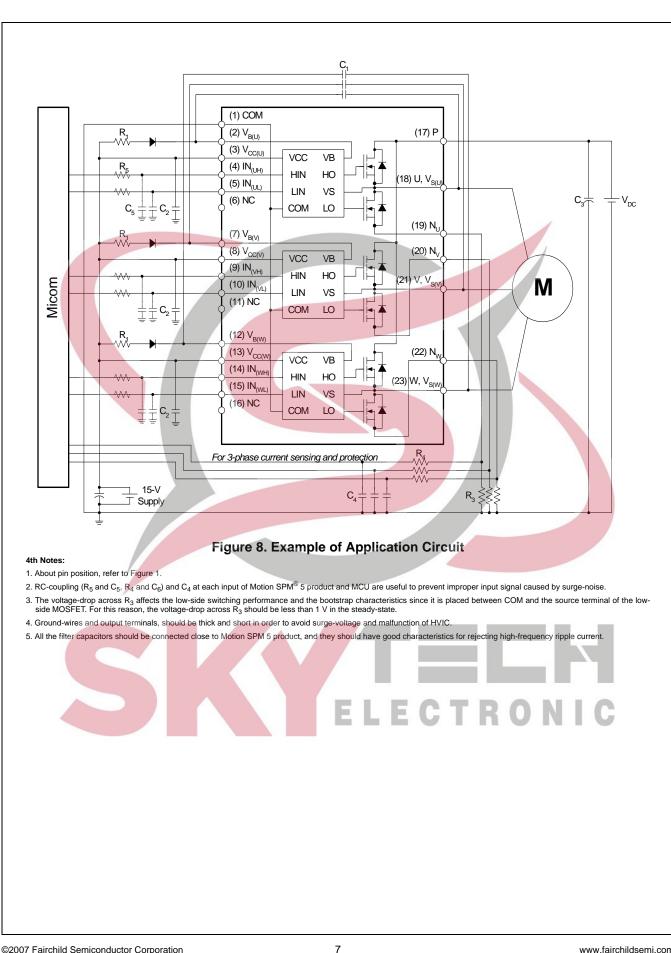
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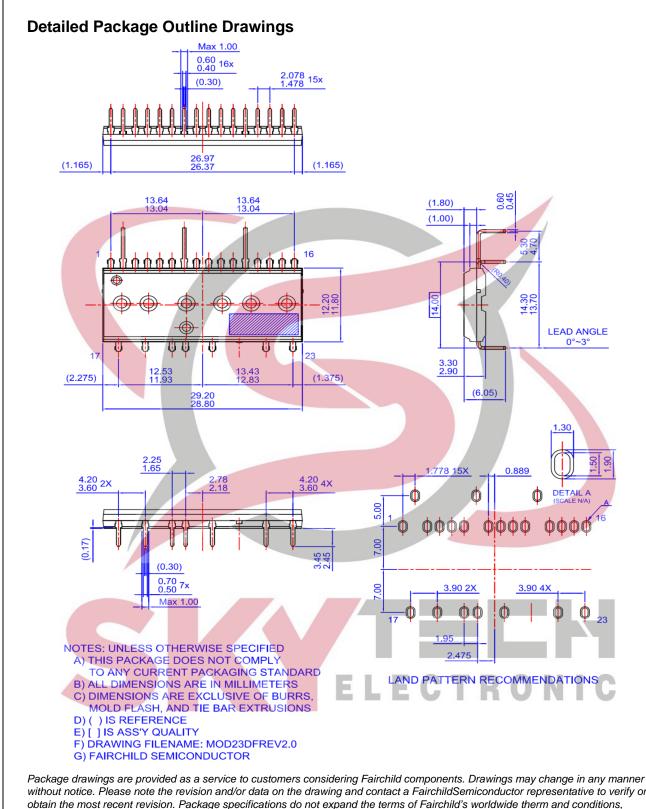


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